SHARP

OPTO-ELECTRONIC DEVICES DIVISION ELECTRONIC COMPONENTS GROUP SHARP CORPORATION

SPECIFICATION

DEVICE	SPECIFICATION FOR
	DI ECH ICALION FOR

PHOTOTRIAC COUPLER

MODEL No.

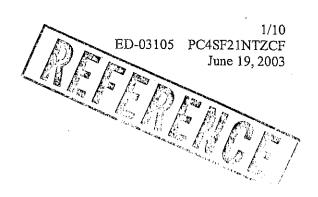
4SF21

Business dealing name	Business dealing name
PC4SF21NTZCF	PC4SF21YTZCF

Specified for	
Enclosed please find copies of the Specifications v	
After confirmation of the contents, please be sure twith approving signature on each.	to send back copies of the Specifications
CUSTOMER'S APPROVAL	PRESENTED
DATE	DATE
ВУ	BY K.H
	K. Hachimura, Department General Manager of Engineering Dept.,II Opto-Electronic Devices Div.

ELECOM Group

SHARP CORPORATION



Product name: PHOTOTRIAC COUPLER

Model No.: 4SF21

(Business dealing name: PC4SF21NTZCF) (Business dealing name: PC4SF21YTZCF)

- 1. These specification sheets include materials protected under copyright of Sharp Corporation ("Sharp"). Please do not reproduce or cause anyone to reproduce them without Sharp's consent.
- 2. When using this product, please observe the absolute maximum ratings and the instructions for use outlined in these specification sheets, as well as the precautions mentioned below. Sharp assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets, and the precautions mentioned below.

(Precautions)

- (1) This product is designed for use in the following application areas;
 - · OA equipment · Audio visual equipment · Home appliances
 - · Telecommunication equipment (Terminal) · Measuring equipment
 - · Tooling machines · Computers

If the use of the product in the above application areas is for equipment listed in paragraphs (2) or (3), please be sure to observe the precautions given in those respective paragraphs.

- (2) Appropriate measures, such as fail-safe design and redundant design considering the safety design of the overall system and equipment, should be taken to ensure reliability and safety when this product is used for equipment which demands high reliability and safety in function and precision, such as;
 - · Transportation control and safety equipment (aircraft, train, automobile etc.)
 - · Traffic signals · Gas leakage sensor breakers · Rescue and security equipment
 - Other safety equipment etc.
- (3) Please do not use this product for equipment which require extremely high reliability and safety in function and precision, such as;
 - · Space equipment · Telecommunication equipment (for trunk lines)
 - Nuclear power control equipment Medical equipment etc.
- (4) Please contact and consult with a Sharp sales representative if there are any questions regarding interpretation of the above three paragraphs.
- 3. Please contact and consult with a Sharp sales representative for any questions about this product.

1. Application

This specification applies to the outline and characteristics of phototriac coupler Model No. 4SF21 (Apply line voltage 200V AC

2. Outline

Refer to the attached sheet, page 4.

3. Ratings and characteristics

Refer to the attached sheet, page 5, 6.

4. Reliability

Refer to the attached sheet, page 7.

5. Outgoing inspection

Refer to the attached sheet, page 8.

6. Supplement

6.1 Business dealing name

("O" mark indicates business dealing name of ordered product)

Product	Business dealing name	Remarks
	PC4SF21NTZCF	
	PC4SF21YTZCF	* Applied to products as an option (Attachment-1-1 to 3)

6.2 Package specification

Refer to the attached sheet, page 9, 10.

- 6.3 Isolation voltage shall be measured in the following method.
 - (1) Short between pins 1 to 3 on the primary side and between pins 4 to 6 on the secondary side.
 - (2) The dielectric withstand tester with zero-cross circuit shall be used.
 - (3) The wave form of applied voltage shall be a sine wave.

(It is recommended that the isolation voltage be measured in insulation oil.)

6.4 This Model is approved by UL, CSA.

Approved Model No.: 4SF21

UL file No. : E64380

CSA file No.: CA95323

CSA approved mark "

(I)

"shall be indicated on sleeve package.

6.5 This product is approved by BSI, SEMKO, DEMKO and FIMKO

Approved Model No.: 4SF21

BSI Certificate No.: 6690/7421 (BS415/BS7002)

SEMKO Certificate No.: 0033029/01-04

DEMKO Certificate No.: 310107-01

FIMKO Certificate No.: 15795

6.6 This product is not designed against irradiation.

This product is assembled with electrical input and output.

This product incorporates non-coherent light emitting diode.

6.7 ODS materials

This product shall not contain the following materials.

Also, the following materials shall not be used in the production process for this product.

Materials for ODS : CFC_S, Halon, Carbon tetrachloride, 1.1.1-Trichloroethane (Methyl chloroform)

6.8 Brominated flame retardants

Specific brominated flame retardants such as the PBBOs and PBBs are not used in this device at all.

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7. Notes

7.1 Before the circuit design

The LED used in the Phototriac coupler generally decreases the light emission power by operation. In case of long operation time, please decide I_F value as 2 times or more of the Maximum value (%) of the Minimum triggering current at circuit design with considering the decreases of the light emission power of the LED. (50%/5years)

(2) Input current (I_F) at off state shall be set 0.1mA or less.

(3) In case that L (Inductance) load such as motor etc. is used, please use this device after confirming whether this device operates normally in actual condition since there is a case that the zero cross circuit works and the load does not turn on thanks to the phase difference of load current.

(4) If the voltage exceeding the repetitive peak off-state voltage (V_{DRM}) in the absolute maximum ratings is applied to the phototriac, it may cause not only faulty operation but breakdown. Make sure that the surge voltage exceeding V_{DRM} shall not be applied by using the varistor, CR.

7.2 Usage

For triggering medium and high power triac. (This model shall be used in the ON state condition of triggering power triac.)

7.3 For cleaning

Solvent cleaning: Solvent temperature 45°C or less, Immersion for 3 min or less

Ultrasonic cleaning: The effect to device by ultrasonic cleaning differs

by cleaning bath size, ultrasonic power

output, cleaning time, PCB size or device mounting condition etc.

Please test it in actual using condition

and confirm that doesn't occur any defect before starting the ultrasonic cleaning.

(3) Applicable solvent: Ethyl alcohol, Methyl alcohol, Isopropyl alcohol

When the other solvent is used, there are cases that the packaging resin is eroded.

Please use the other solvent after thorough confirmation is performed in actual using condition.

7.4 Precautions for Soldering Phototriac couplers

In the case of flow soldering (Whole device dipping) t is recommended that flow solder be at 270°C and within 10 seconds (Pre-heating: 100 to 150°C, 30 to 80 seconds). (2 times or less)

In the case of hand soldering

What is done on the following condition is recommended. (2 times or less)

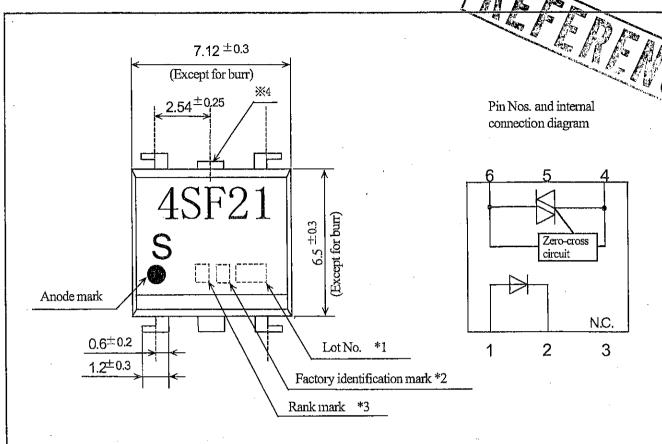
Soldering iron temperature: 390±10°C

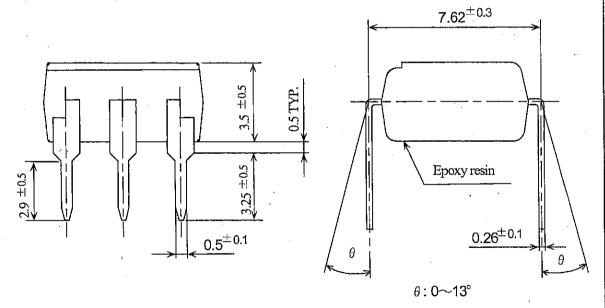
Time: 3s or less

Other precautions

Depend on equipment and soldering conditions (temperature, Using solder etc.), the effect to junction between PCB and lead pins of photocoupler is different.

Please confirm that there is no problem on the actual use conditions.





- *1) 2-digit number shall be marked according to DIN standard.
- *2) Factory identification mark shall be or shall not be marked.
- *3) Rank mark: "C"
- *4) Pin 5 is not allowed external connection.

Pin 5 is cut at outside of package.

*5) Lead material: Cu Alloy

Lead finish: SnCu plating (Cu: TYP. 2%)

Product mass	•	Approx 0.35g

	UNIT: 1/1 mm
	4SF21
Name	Outline Dimensions
	(Business dealing
	name: PC4SF21NTZCF)

June 19, 2003

3.1 Absolute maximum ratings

Absolute m	aximum ratings		Ta=25		June 19, 2003
	Parameter	Symbol	Rating	Unit	The Arian
Turnet	Forward current *1	I_{F}	50	mA	
Input	Reverse voltage	V _R	6	V	
	RMS on-state current *1	I _T (rms)	0.1	A	
Output	Peak one cycle surge current	Isurge	1.2 (50Hz sine wave)	A	
	Repetitive peak off-state voltage	V_{DRM}	800	V	
	, Isolation voltage *2	Viso(ms)	5	kV	
	Operating temperature	Topr	-30 to +100	ొ	
	Storage temperature	Tstg	-55 to +125	°C	
	Soldering temperature	Tsol	270 (For 10s)	°C	

^{*1} The derating factors of absolute maximum rating due to ambient temperature are shown in Fig.1, 2.

3.2 Electrical characteristics

Ta=25℃

	Parameter	Symbol	MIN.	TYP.	MAX.	Unit	Conditions
Teamant	Forward voltage	V_{F}	-	1.2	1.4	V.	I _F =20mA
Input	Reverse current	I_R	-	-	10 ⁻⁵	A	V _R =3V
	Repetitive peak off-state current	I _{DRM}	-	-	3×10 ⁻⁶	Α	V _D =V _{DRM}
	On-state voltage	V_{T}	-	-	2.5	V	I _T =0.1A
Output	Holding current	I_{H}	0.1		3.5	mA	V _D =4V
	Critical rate of rise of off-state voltage	dv/dt	500	1000	-	V/μs	$V_D=1/\sqrt{2\cdot V_{DRM}}$
	Zero-cross voltage	Vox	-		20 -	V	R load, I _F =8mA
Transfer	Minimum trigger current	I_{FT}	-	-	5	mA	V_D =4V R_L =100 Ω
charac- teristics	Isolation resistance	R _{ISO}	5×10 ¹⁰	10 ¹¹	-	Ω	DC500V 40 to 60%RH
	Turn on time	t _{ON}	-	₩	50	μs	V_D =4V, R_L =100 Ω , I_F =20mA

^{*2} AC for 1min, 40 to 60%RH, f=60Hz

Fig.1 Forward current vs. ambient temperature

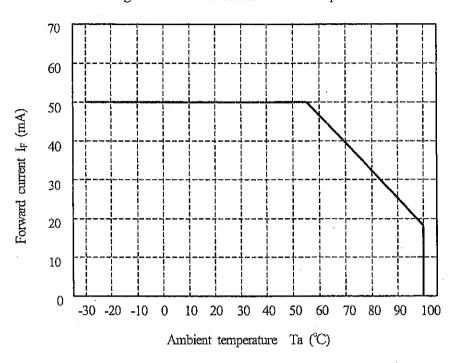
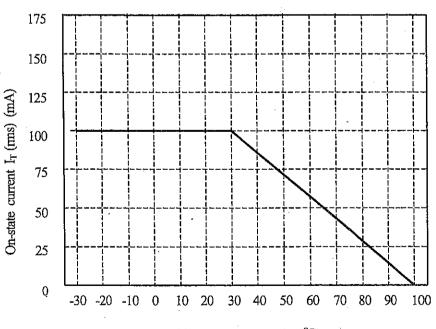


Fig.2 On-state current vs. ambient temperature



Ambient temperature Ta (°C)

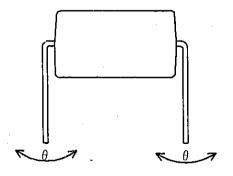
4. Reliability

The reliability of products shall satisfy items listed below.

Confidence level: LTPD: 10 or 20

			. 10 01 20	
Test Items	Test Conditions *1	Failure Judgement	Samples (n)	
		Criteria	Defective(C)	
Solderability *2	245±3℃, 5 s		n=11, C=0	
Soldering heat *3	(Flow soldering) 270°C, 10 s		n=11, C=0	
boldening heat 5	(Soldering by hand) 400°C, 3 s		n 11,0-0	
Terminal strength	Weight: 5.0N		11 ()0	
(Tension)	5 s/each terminal	$V_F>U\times 1.2$	n=11, C=0	
Terminal strength	Weight: 2.5N		11.0.0	
(Bending) *4	2 times/each terminal	$V_T>U\times 1.2$	n=11, C=0	
Mechanical shock	15km/s ² , 0.5ms	·	11.00	
IVIECNAMICAI SNOCK	3 times/ \pm X, \pm Y, \pm Z direction	$I_{FT}>U\times1.3$	n=11, C=0	
Variable frequency	100 to 2000 to 100Hz/4min			
variable frequency vibration	200m/s ²	$I_R>U\times 2.0$	n=11, C=0	
Violation	4 times/ X, Y, Z direction		·	
	I cycle -55°C to +125°C	I _{DRM} >U×2.0		
Temperature cycling	(30min) (30min)		n=22,C=0	
	20 cycles test Without Load	U: Upper specification limit		
High temp. and high	+85°C, 85%RH, 500h		22.00	
humidity storage	+83 C, 8376KH, 300II	L: Lower specification limit	n=22,C=0	
High temp. storage	+125°C, 1000h		n=22,C=0	
Low temp. storage	-55℃, 1000h		n=22,C=0	
Operation life	I _F =50mA, I _T =100mA		n=32 C=0	
Operation me	Ta=25°C, 1000h		n=22,C=0	

- *1 Test method, conforms to EIAJ ED 4701.
- *2 Solder shall adhere at the area of 95% or more of immersed portion of lead, and pin hole or other holes shall not be concentrated on one portion.
- *3 Dip into the position of 1.0mm from the resin part.
- *4 Terminal bending direction is shown below.



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5. Outgoing inspection

- 5.1 Inspection items
 - (1) Electrical characteristics $V_F, I_R, I_{DRM}, V_T, I_{FT}, R_{ISO}, Viso$
 - (2) Appearance
- 5.2 Sampling method and Inspection level

A single sampling plan, normal inspection level II based on ISO 2859 is applied.

The AQL according to the inspection items are shown below.

Defect	Inspection item	AQL(%)	
Major defect	Electrical characteristics Unreadable marking	0.065	
Minor defect	Appearance defect except the above mentioned.	0.25	

6.2 Package specification

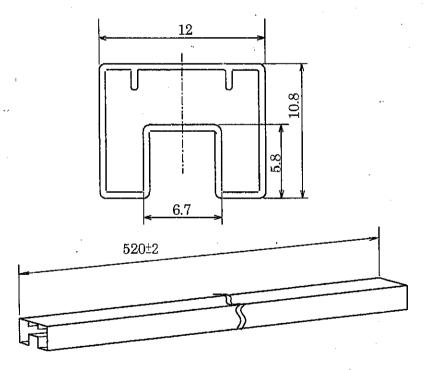
6.2.1 Package materials

1 1 acr	age materials			<u>13</u> P
No.	Name	Materials	Purposes	
①	Sleeve	HIPS with preventing static electricity	Products packaged	
2	Stopper	Styrene-Elastomer	Products fixed	
3	Packing case	Corrugated cardboard	Sleeve packaged	
4	Kraft tape	Paper	Lid of packaged case fixed	
5	Label	Paper	Model No., quantity, inspection date and lot No. specified	·

6.2.2 Package method

- (1) MAX. 50pcs. of products shall be packaged in a sleeve ① and both of sleeve edges shall be fixed by stoppers ②.
- (2) MAX. 20 sleeves (product: 1000pcs.) above shall be packaged in a packing case ③ and pack a sheet of cushion at one side.
- (3) Model No., quantity, inspection date and lot No. shall be marked on the label ⑤ and this label shall be put on the side of the packaging case.
- (4) Case shall be closed with the lid and enclosed with kraft tape 4.

6.2.3 Sleeve package ① outline dimensions

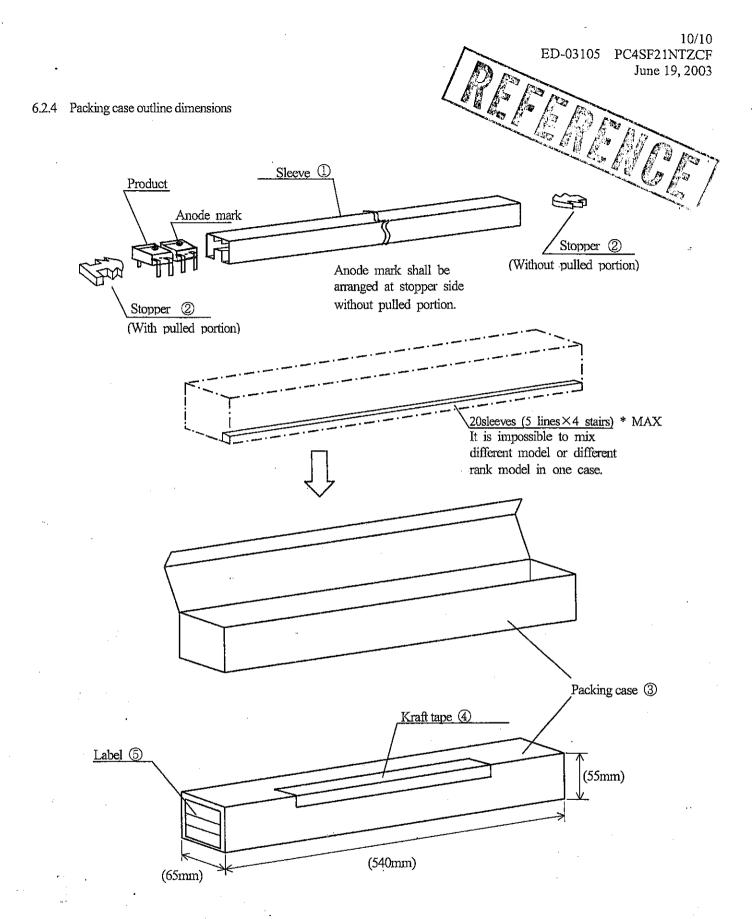


Note 1) Thickness: 0.5 ± 0.2 mm

2) Outer R: 0.5mm

3) Process with applying antistatic treatment.

Unless otherwise specified tolerances shall be ±0.5mm.
 (However except for deformation due to the rubber stopper in sleeve.)



Regular packing mass: Approx. 760g

(): Reference value

Attachment-1-1
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. This specification shall be applied to photocoupler, Model No. 4SF21 series as an option.

2. Applicable Models (Business dealing name)

PC4SF21YTZCF

3. The relevant models are the models Approved by VDE according to DIN VDE0884/08.87.

Model No.: 4SF21

VDE approved No.: 127413 (According to the specification DIN VDE0884/08.87)

Operating isolation voltage U_{IORM(PEAK)}: 890V

Transient voltage U_{TR(PEAK)}: 6000V

• Pollution: 2 (According to VDE0110/01.89)

· Clearances distance (Between input and output): 8.0mm (MIN.)

• Creepage distance (Between input and output): 8.0mm (MIN.)

• Isolation thickness between input and output: 0.40mm (MIN.)

• Tracking-proof: CTI 175 (Material group IIIa: VDE0110/01.89)

· Safety limit values

Current (Isi): 200mA (Diode side)

Power (Psi) : 400mW (Phototriac side)

Temperature (Tsi): 150°C

In order to keep safety electric isolation of photocoupler, please set the protective circuit to keep within safety limit values when the actual application equipment troubled.

· Indication of VDE approval prints "



0884" on sleeve package.

4. Outline

Refer to the attachment-3-2.

5. Isolation specification according to VDE 0884

Parameter		Symbol	Conditions	Rating	Unit	Remark	
Class of environmental test		-	DIN IEC68	30/100/21	-		
Polluti	on		-	DIN VDE0110	2	-	.
Maxin	num operating	g isolation voltage	U _{IORM(PEAK)}	-	890	V	Refer to
Partial	discharge tes	t voltage					the Dia-
(Betwe	een input and	output)			:		gram 1, 2
		Diagram 1	T Years	tp=60 s, qc<5pC	1068	V	(Attachment -1-3)
j		Diagram 2	Upr _(PEAK)	tp=1 s, qc < 5pC	1424	V	-1-3)
Maxin	num over-vol	tage	U _{INITIAL(PEAK)}	t _{INĪ} =10 s	6000	V	
Safety	maximum ra	tings					
	1) Case to	amperature	Tsi	I _F =0, Pc=0	150	J.	Refer to
٠.	2) Input c	urrent	Isi	Pc=0	200	mA	Fig.1, 2
	1 1	c power Fotal power dissipation)	Psi	-	400	mW	(Attachment -1-3)
Isolation resistance			Ta=Tsi	MIN. 10 ⁹			
(Test voltage between input and output;		R _{ISO}	Ta=Topr (MAX.)	MIN. 10 ¹¹	Ω		
DC:	500V)			Ta=25°C	MJN. 10 ¹²		

6. Precautions in performing isolation test

- 6.1 Partial discharge test methods shall be the ones according to the specifications of VDE 0884/08.87
- · 6.2 Please don't carry out isolation test (Viso) over U_{INITIAL}.

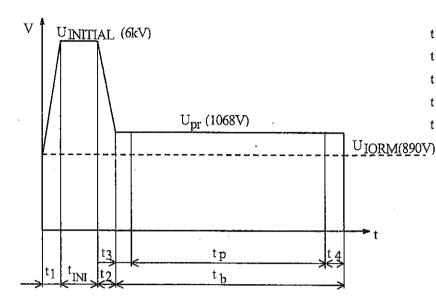
This product deteriorates isolation characteristics by partial discharge due to applying high voltage (ex. UINITIAL). And there is possibility that this product occurs partial discharge in operating isolation voltage. (U_{IORM})

ED-03105 PC4SF21YTZCF June 19, 2003 7.12 ± 0.3 (Except for burr) Pin Nos. and internal connection diagram 4SF21 Except for burr) Zero-cross circuit Anode mark N.C. $0.6^{\pm0.2}$ Lot No. 2 3 Factory identification mark *2 Rank mark *3 VDE 0884 identification mark $7.62^{\pm0.3}$ Epoxy resin 0.26^{±0.1} <u>0.</u>5^{±0.1} *1) 2-digit number shall be marked according to DIN standard. $\theta: 0 \sim 13^{\circ}$ *2) Factory identification mark shall be or shall not be marked. *3) Rank mark: "C" *4) VDE identification mark shall be marked "4" *5) Pin 5 is not allowed external connection. Pin 5 is cut at outside of package. *6) Lead material: Cu Alloy Lead finish: SnCu plating (Cu: TYP. 2%) UNIT: 1/1 mm 4SF21 Outline Dimensions Product mass : Approx.0.35g Name (Business dealing name: PC4SF21YTZCF)

Attachment-1-2

Attachment-1-3
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Method of Diagram 1: Breakdown test (Apply to type test and sampling test)



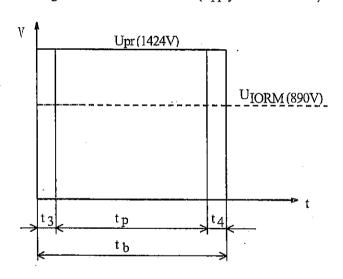
t₁, t₂ = 1 to 10 s

t₃, t₄ = 1 s

t_p (Partial discharge measuring time)
t_b =62 s

t_{INI} =10 s

Method of Diagram 2: Non breakdown test (Apply to all device test)



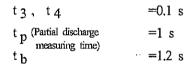


Fig. 1 Safety maximum power dissipation vs. ambient temperature

